

Toshiba Intelligent Power Device Silicon Monolithic Power MOS Integrated Circuit

TPD1038F

Motor, Solenoid, Lamp Drivers

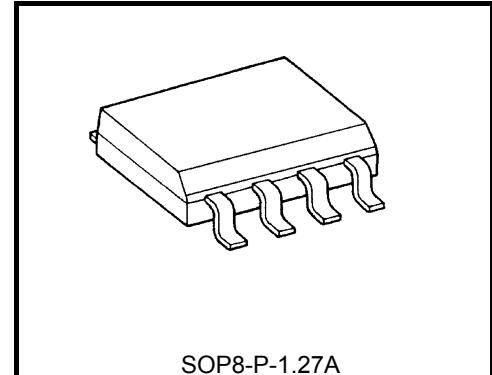
High-side Power Switch

The TPD1038F is a monolithic power IC for high-side switches. The IC has a vertical MOS FET output which can be directly driven from a CMOS or TTL logic circuit (e.g., an MPU). The device offers intelligent self-protection and diagnostic functions.

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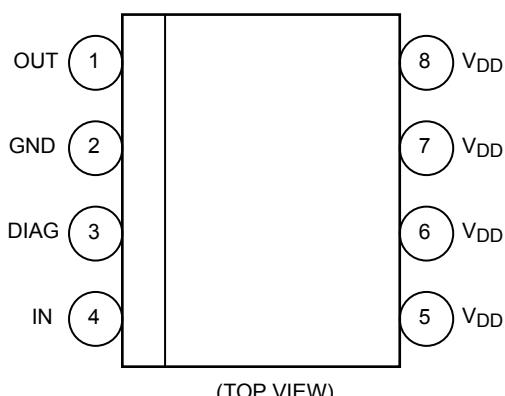
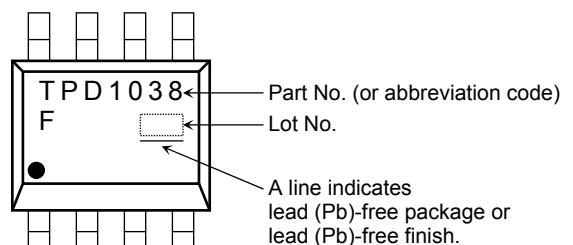
Features

- A monolithic power IC with a structure combining a control block (Bi-CMOS) and a vertical power MOS FET on a single chip.
- One side of load can be grounded to a high-side switch.
- Can directly drive a power load from a microprocessor.
- Built-in protection against overheating and load short-circuiting.
- Incorporates a diagnosis function that allows diagnosis output to be read externally at load short-circuiting, opening, or overheating.
- Up to $-(50-V_{DD}) \sim -(60-V_{DD})$ of counterelectromotive force from an L load can be applied.
- Low on-resistance : $R_{DS(ON)}=120\text{m}\Omega$ (max) (@ $V_{DD} = 12\text{ V}$ 、 $T_a = 25^\circ\text{C}$ 、 $I_o = 2\text{ A}$)
- 8-pin SOP package for surface mounting that can be packed in tape

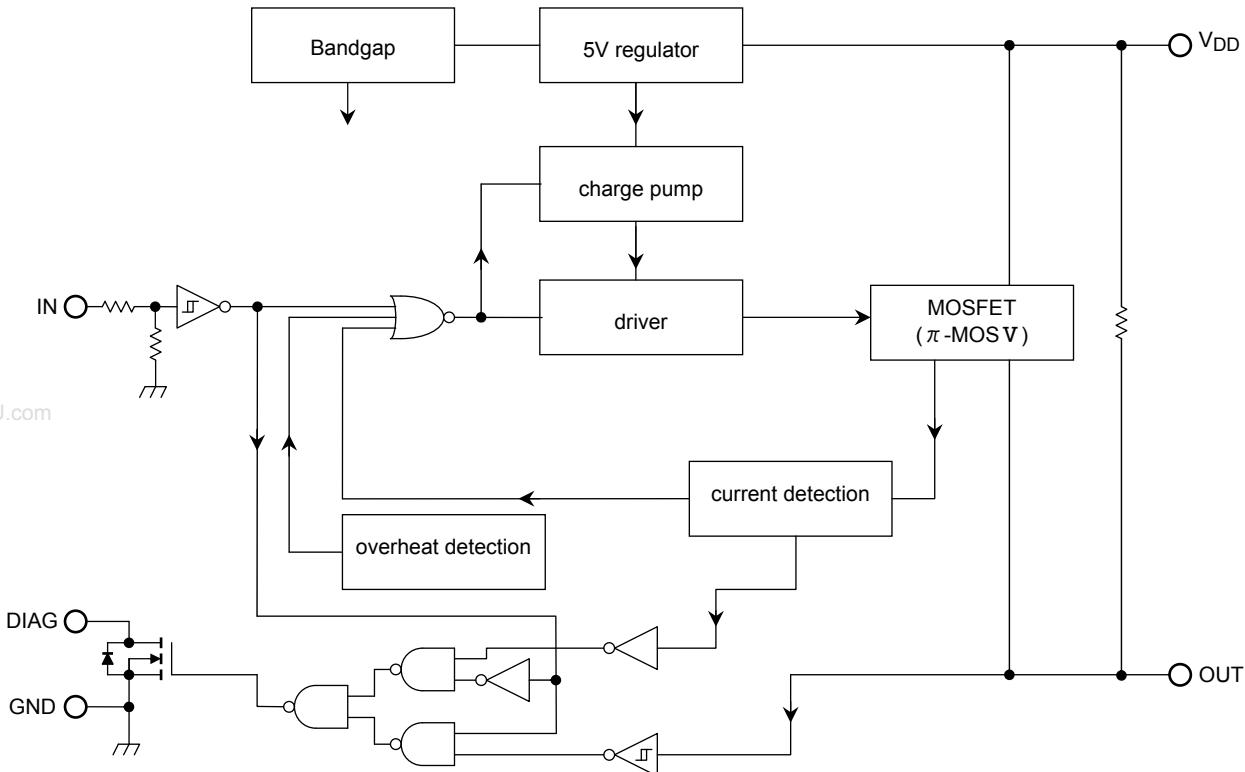


SOP8-P-1.27A

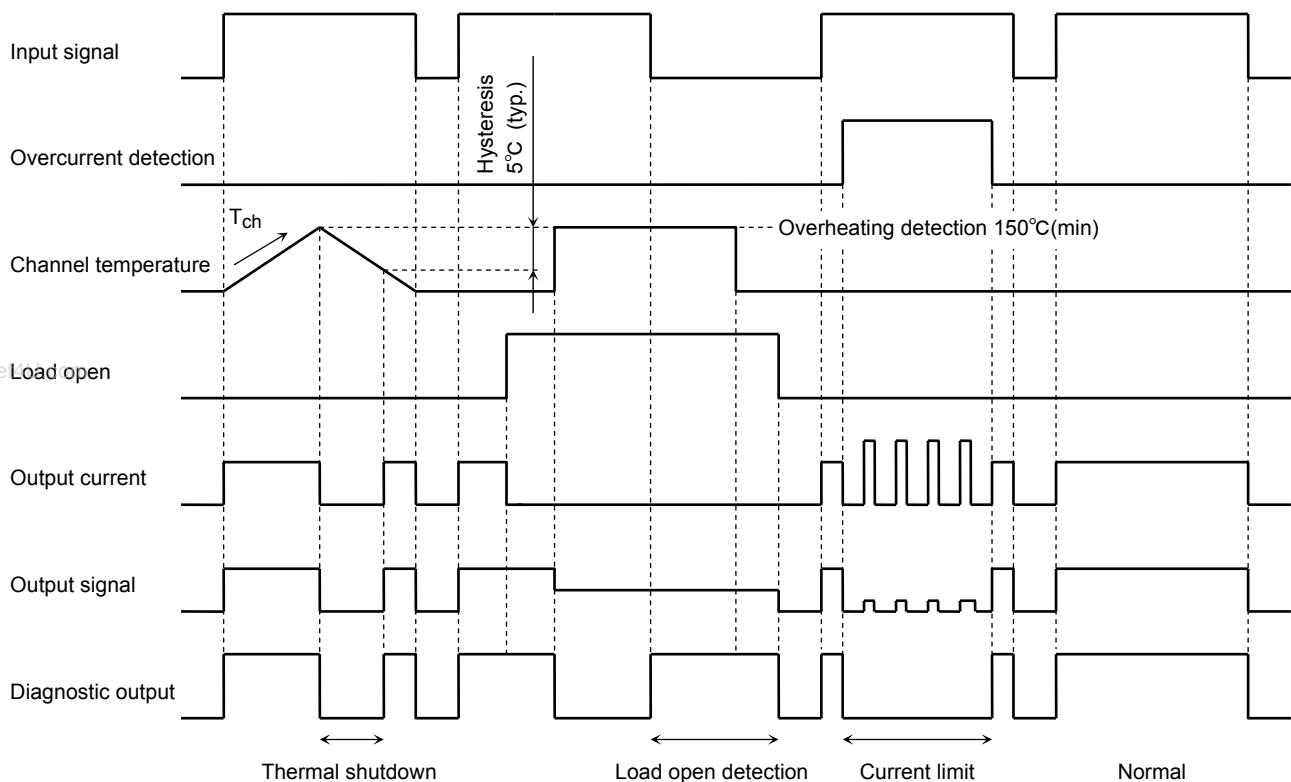
Weight : 0.08g(typ.)

Pin Assignment**Marking**

Due to its MOS structure, this product is sensitive to static electricity.

Block Diagram**Pin Description**

Pin No.	Symbol	Function
1	OUT	Output pin. When the load is short-circuited and current in excess of the detection current (3A min) flows to the output pin, the output automatically turns on or off.
2	GND	Ground pin.
3	DIAG	Self-diagnosis detection pin. Goes low when overheating is detected or when output is short circuit with input on (high). N-channel open drain.
4	IN	Input pin. Input is CMOS compatible, with pull down resistor connected. Even if the input is open, output will not accidentally turn on.
5,6,7,8	V _{DD}	Power pin.

Timing Chart**Truth Table**

Input signal	Diagnosis output	Output signal	Output state	Operating state
H	H	H	on	Normal
L	L	L	off	
H	L	L	current limit (switching)	Load short
L	L	L	off	
H	L	L	off	Overheating
L	L	L	off	
H	H	H	on	Load open
L	H	H	off	
H	L	L	off	Overheating and load open
L	H	H	off	

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V _{DS}	60	V
Supply voltage	DC	V _{DD(1)}	25	V
	Pulse	V _{DD(2)}	60(R _S =1Ω, τ=250ms)	V
Input voltage	DC	V _{IN(1)}	-0.5~12	V
	Pulse	V _{IN(2)}	V _{DD(1)} +1.5(t=100ms)	V
Diagnosis output voltage		V _{DIAG}	-0.5~25	V
Output current		I _O	Internally limited	A
Input current		I _{IN}	±10	mA
Diagnosis current		I _{DIAG}	5	mA
Power dissipation (Note 1-a)		P _{D(1)}	1.1	W
Power dissipation (Note 1-b)		P _{D(2)}	0.425	W
Operating temperature		T _{opr}	-40~110	°C
Channel temperature		T _{ch}	150	°C
Storage temperature		T _{stg}	-55~150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

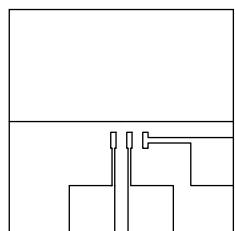
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Resistance

Characteristic	Symbol	Rating	Unit
Thermal resistance	R _{th(ch-a)}	113.5 (Note1-a)	°C /W
		294.0 (Note1-b)	

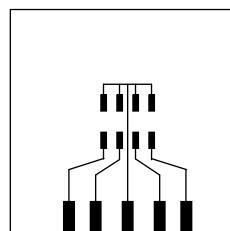
Note 1:

1-a : Mounted on glass epoxy board (a)



FR-4
25.4 × 25.4 × 0.8
(Unit : mm)

1-b : Mounted on glass epoxy board (b)



FR-4
25.4 × 25.4 × 0.8
(Unit : mm)

Electrical Characteristics ($T_a=25^\circ C$)

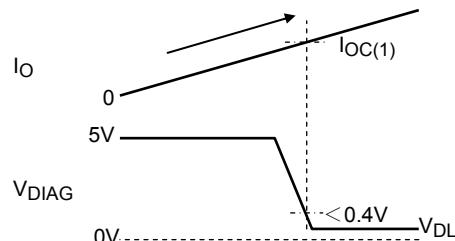
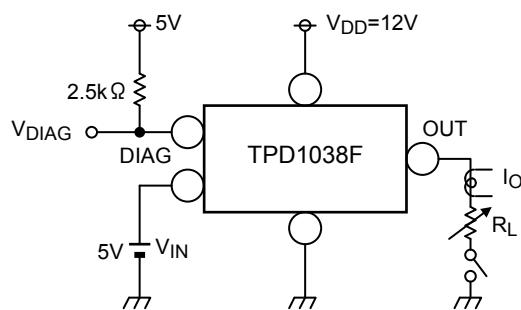
Characteristics		Symbol	Test circuit	Test condition		min	typ.	max	Unit
Operating supply voltage		$V_{DD(OPR)}$	—	—		6	12	18	V
Current dissipation		I_{DD}	—	$V_{DD}=12V, V_{IN}=0V, R_L=10\Omega$		—	—	3	mA
H-level input voltage		V_{IH}	—	$V_{DD}=12V$		3.5	—	—	V
L-level input voltage		V_{IL}	—	$V_{DD}=12V$		—	—	1.5	V
H-level input current		I_{IH}	—	$V_{DD}=12V, V_{IN}=5V$		—	—	200	μA
On resistance		$R_{DS(ON)}$	—	$V_{DD}=12V, I_O=2A$		—	—	0.12	Ω
Output leakage current		I_{OL}	—	$V_{DD}=12V$		—	—	1	mA
Diagnosis output voltage	"L"-level	V_{DL}	—	$V_{DD}=12V, V_{IN}=0V, I_{DL}=1mA$ $R_L=10\Omega$		—	—	0.4	V
Diagnosis output current	"H"-level	I_{DH}	—	$V_{DD}=12V, V_{IN}=5V, R_L=10\Omega$, $V_{DH}=12V$		—	—	10	μA
Over current detection	$I_{OC(1)}$ (Note2)	1,2	$V_{DD}=12V$		3	—	9	A	
		3	$V_{DD}=12V, R_L=0.1\Omega$		—	—	10	A	
Overheating detection	T_{OT}	—	$V_{DD}=12V$		150	—	200	$^\circ C$	
Load open detection (Note4)	R_{op}	—	$V_{DD}=12V, V_{IN}=0V$		5	17	—	$k\Omega$	
Switching time	t_{on}	4	$V_{DD}=12V, R_L=10\Omega$		—	—	100	μs	
	t_{off}		$V_{DD}=12V, R_L=10\Omega$		—	—	40	μs	
Diagnosis delay time	t_{DLH}	5	$V_{DD}=12V, R_L=10\Omega$		—	70	—	μs	
	t_{DHL}		$V_{DD}=12V, R_L=10\Omega$		—	22	—	μs	
Output clamp voltage	V_{clamp}	—	$V_{DD}=12V, V_{IN}=0V, I_O=1A, L=10mH$		$-(60-V_{DD})$	—	$-(50-V_{DD})$	V	

(Note 2) Over-current detection

(Note 3) Peak current @ current limit function

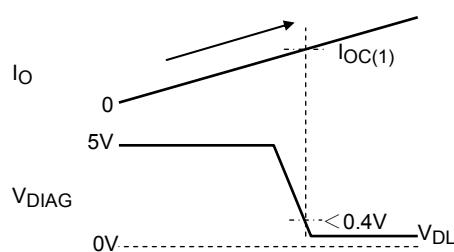
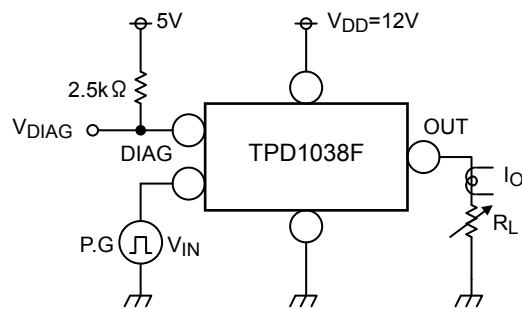
(Note 4) Load open detection function : $V_{DD} = 8 \sim 18V$

Test Circuit 1

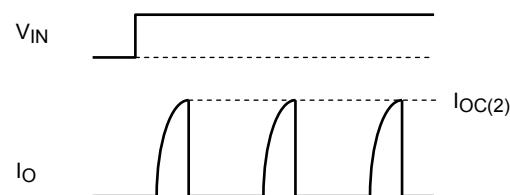
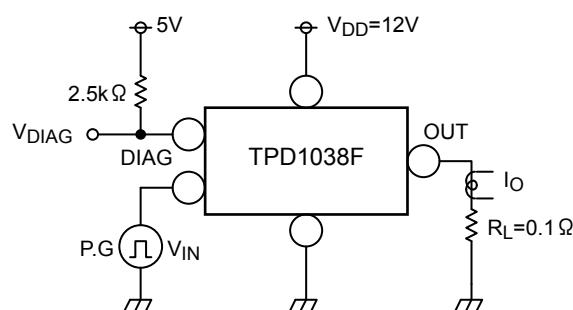
Over current detection $I_{OC(1)}$: Over current detection when load current is increased while $V_{IN} = "H"$ 

Test Circuit 2

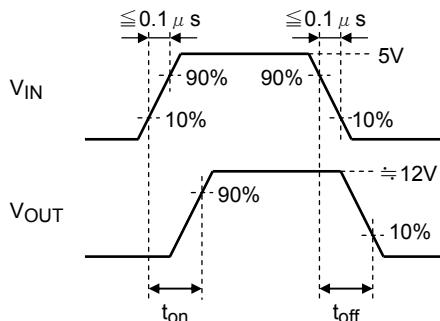
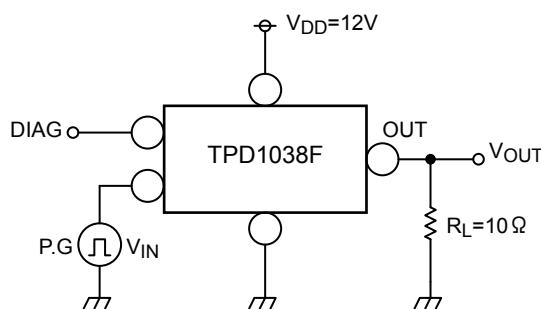
Over current detection $I_{OC(1)}$: Over current detection when load is short circuit and $VIN = "L" \rightarrow "H"$

**Test Circuit 3**

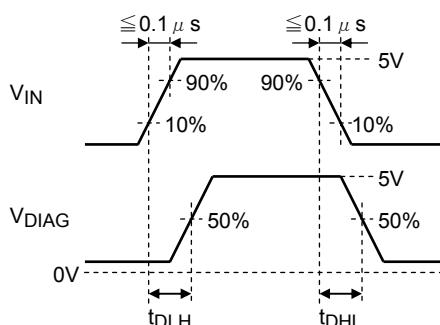
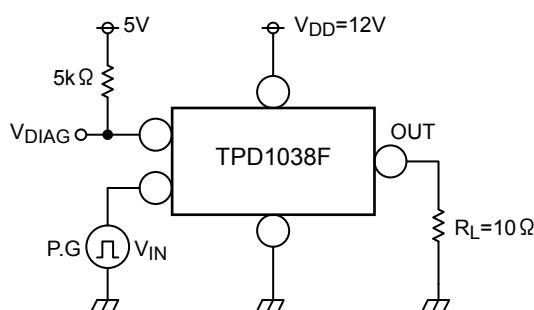
Over current detection $I_{OC(2)}$

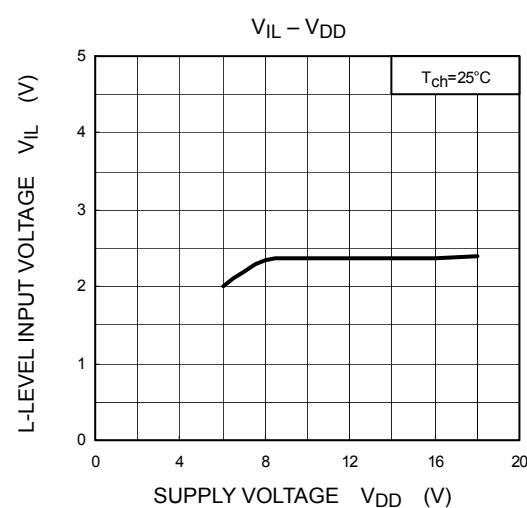
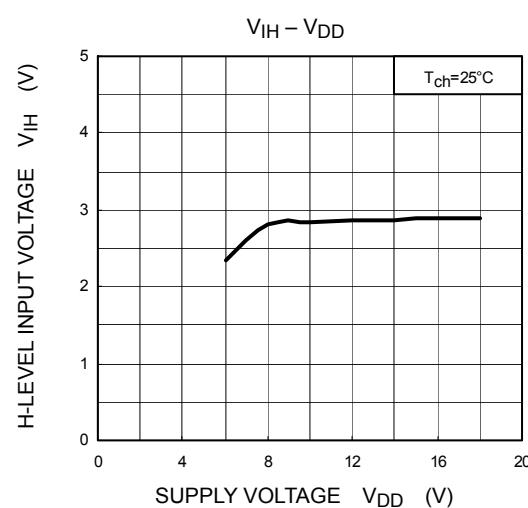
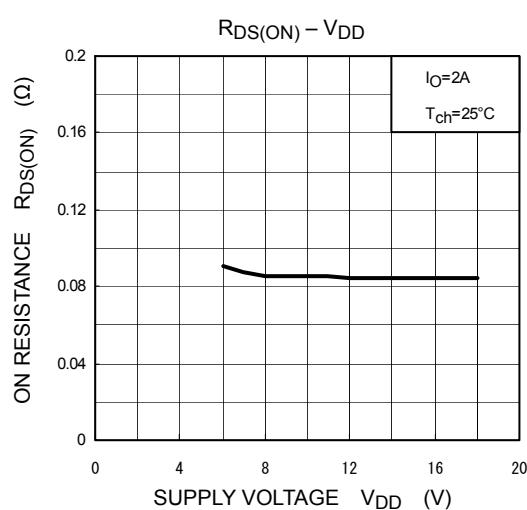
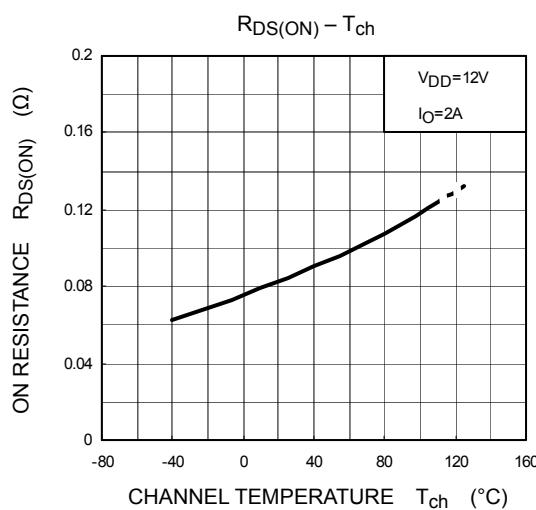
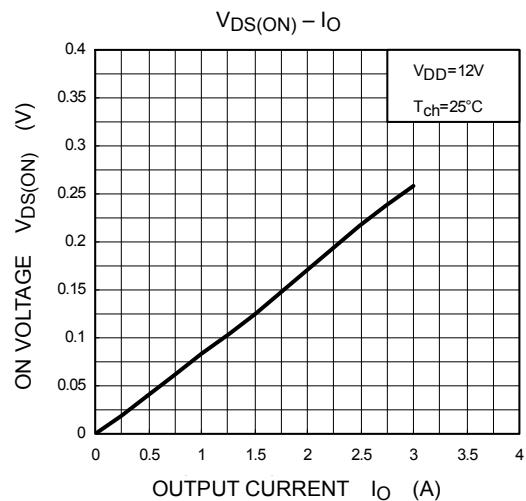
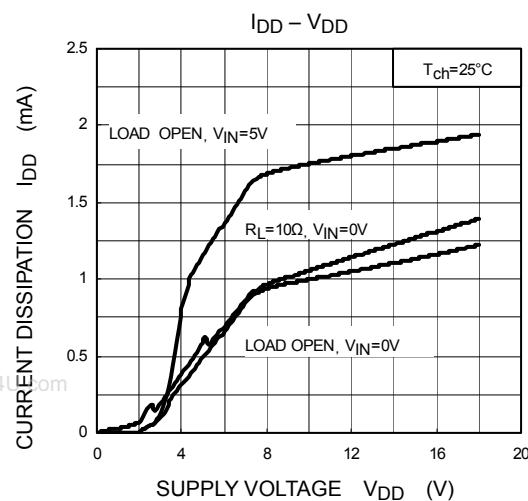
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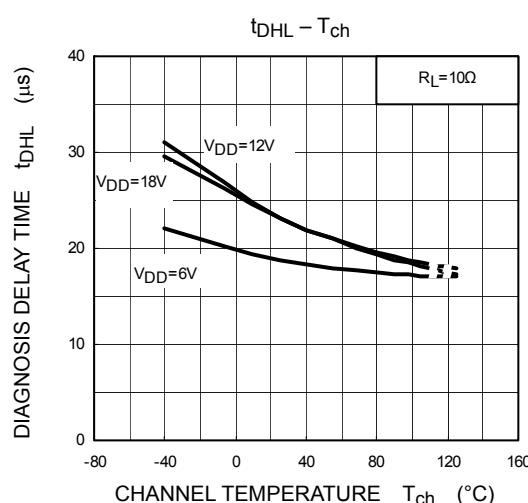
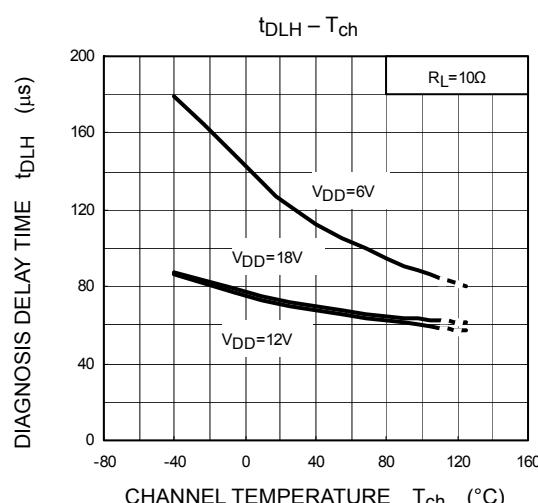
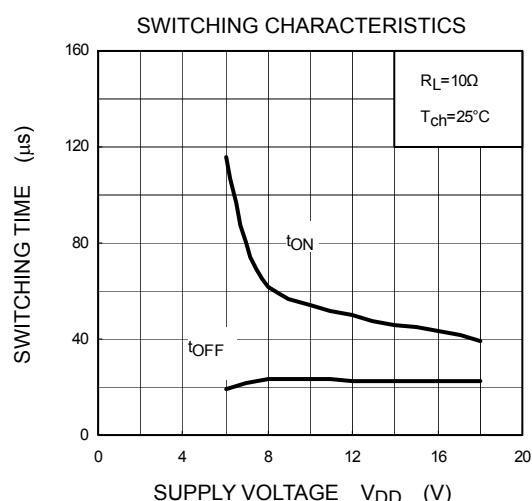
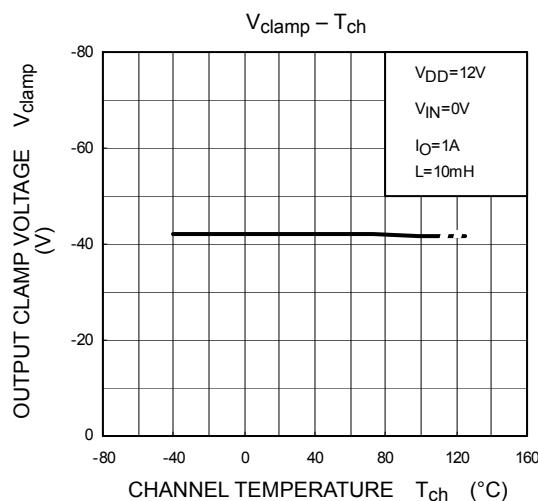
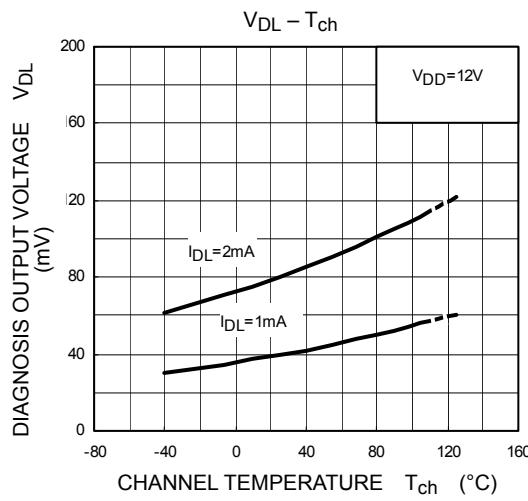
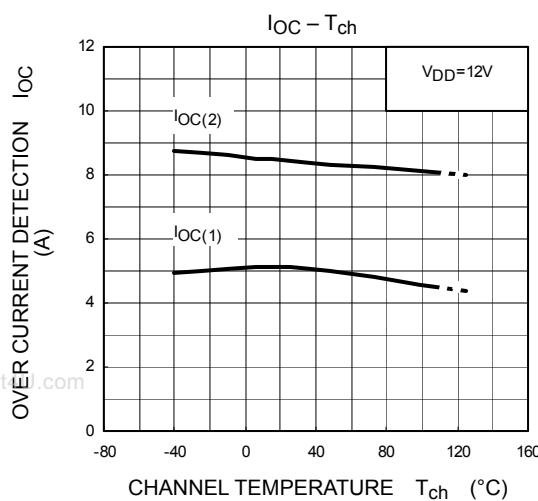
Switching time t_{on}, t_{off}

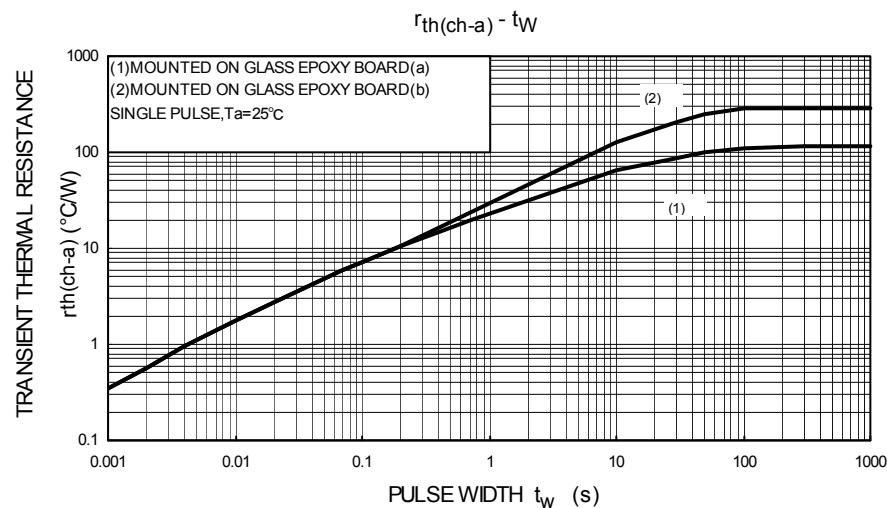
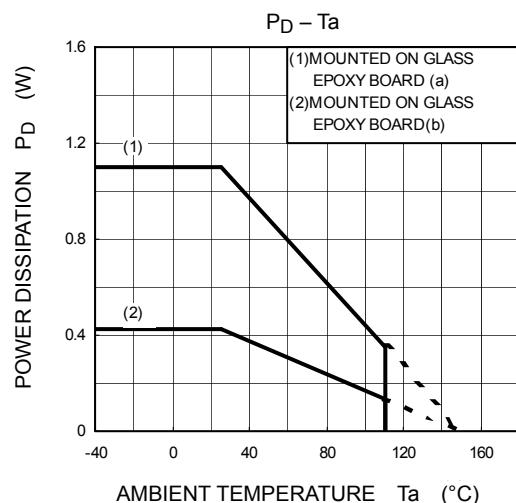
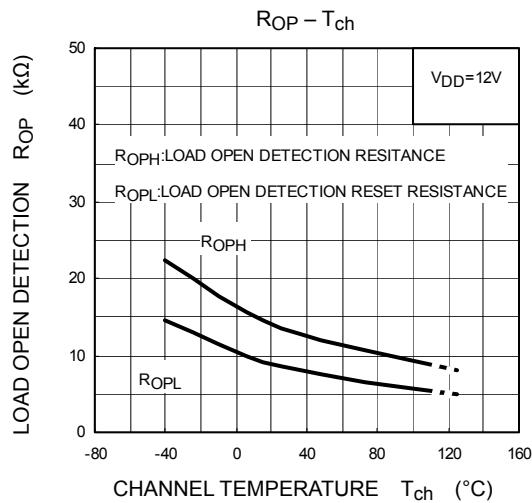
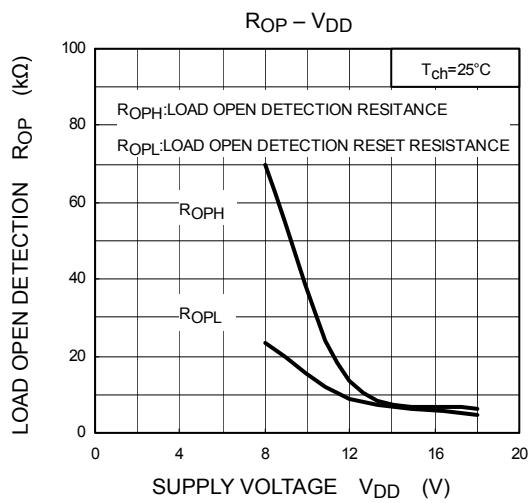
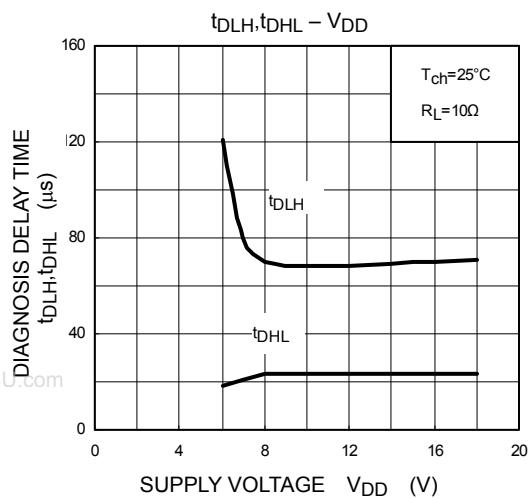
**Test Circuit 5**

Diagnosis delay time t_{DLH}, t_{DHL}



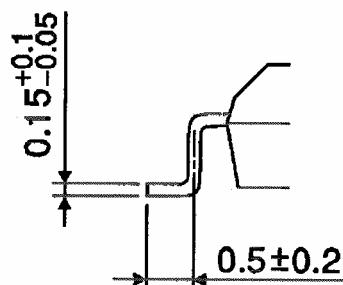
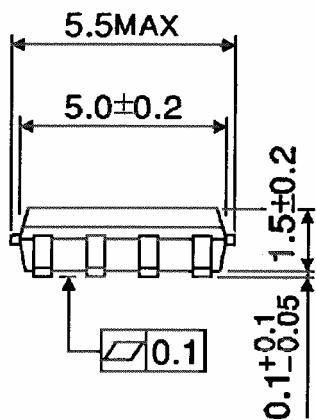
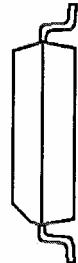
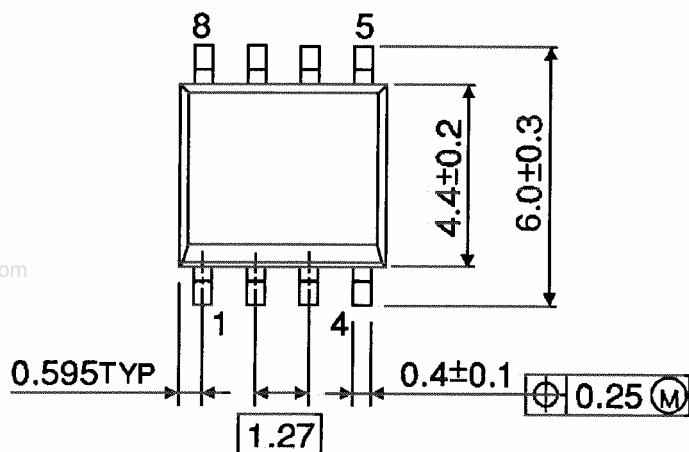






Package Dimensions

SOP8-P-1.27A



Weight: 0.08g (typ.)

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